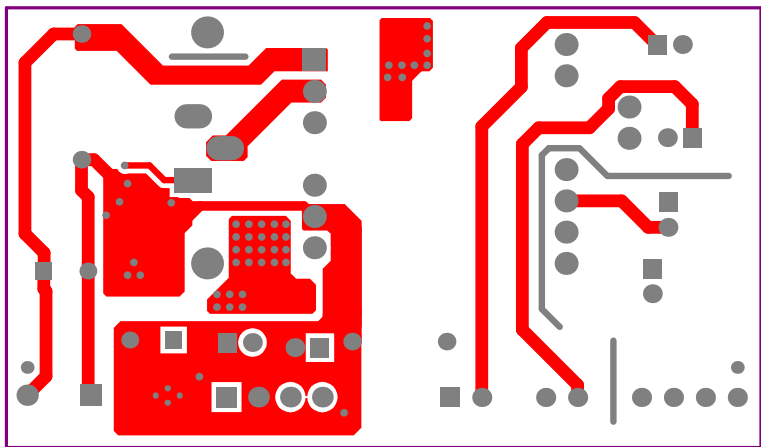
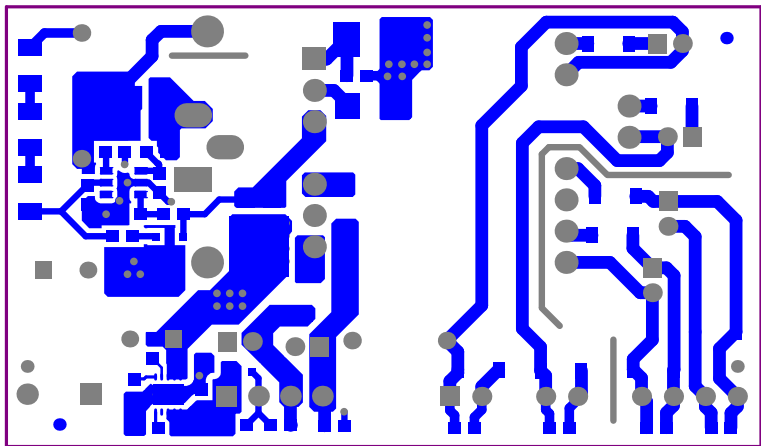
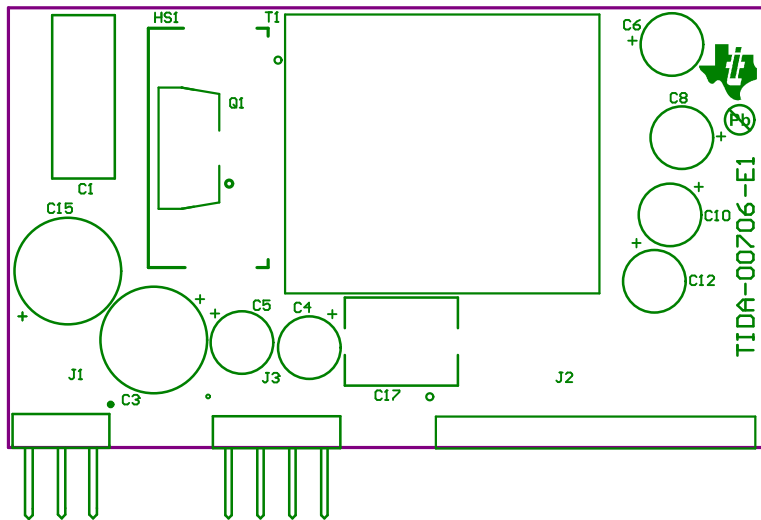




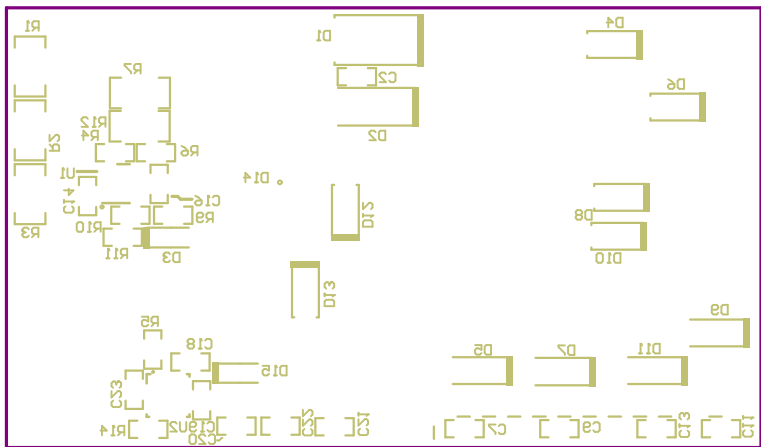
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00706	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-00706		
PLOT NAME = TopLayer	GENERATED : 4/21/2016 9:32:37 AM		TEXAS INSTRUMENTS



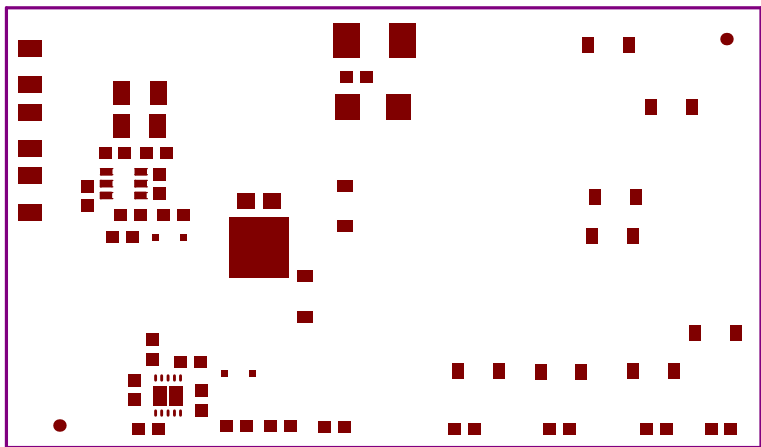
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00706	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-00706		
PLOT NAME = Bottom Layer	GENERATED : 4/21/2016 9:32:38 AM		TEXAS INSTRUMENTS



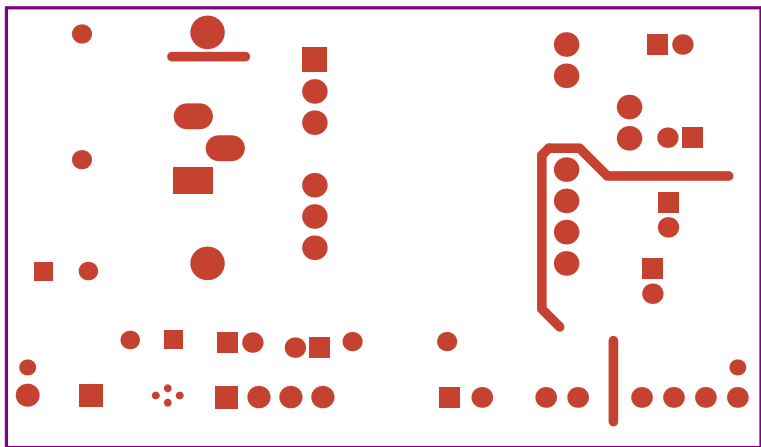
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00706	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-00706		
PLOT NAME = Top Silkscreen Overlay	GENERATED : 4/21/2016	9:32:38 AM	TEXAS INSTRUMENTS



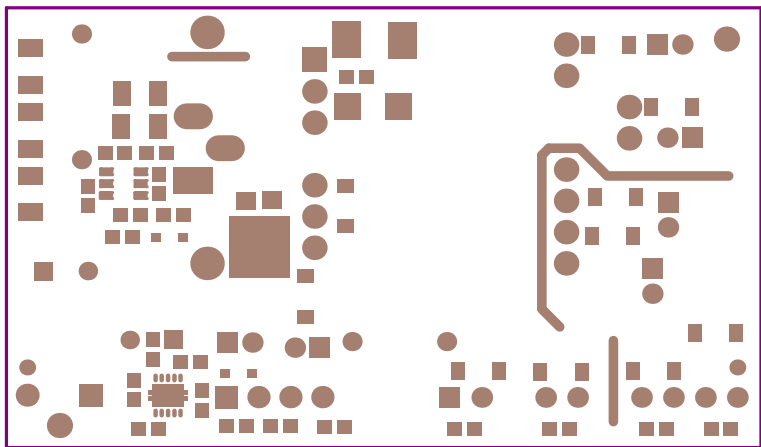
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00706	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-00706		
PLOT NAME = Bottom Silkscreen Overlay	GENERATED : 4/21/2016	9:32:38 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00706	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Paste	TID #: TIDA-00706		
PLOT NAME = Bottom Paste Mask Print	GENERATED : 4/21/2016 9:32:39 AM		TEXAS INSTRUMENTS



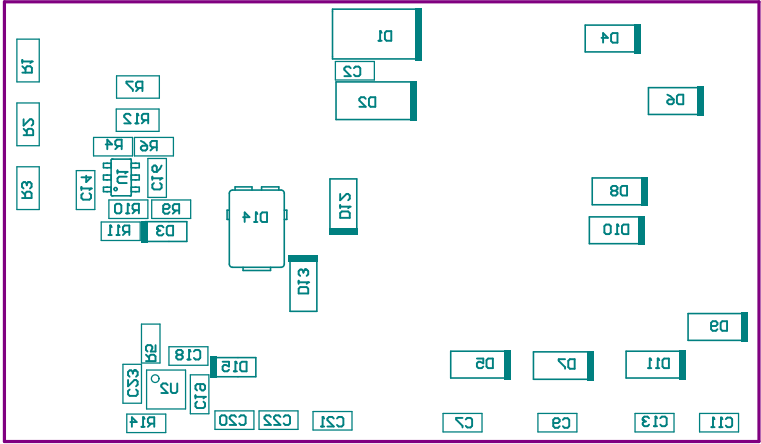
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00706	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-00706		
PLOT NAME = Top Solder Mask Print	GENERATED : 4/21/2016	9:32:39 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00706	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-00706		
PLOT NAME = Bottom Solder Mask Print	GENERATED : 4/21/2016	9:32:40 AM	TEXAS INSTRUMENTS

PLOT NAME = ME Assembly Bottom	GENERATED : 4/21/2016 9:35:41 AM	TEXAS INSTRUMENTS
ME Assembly Bottom	TID #: TIDA-00706	
PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00706	REV: E1
SUN REV: Not In VersionControl		

ASSEMBLY VARIANT: [no Variations]
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.



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